Patent Claims:

1. Blister package arrangement with a blister package (1) and a conductor carrier strip (10) connected to it, wherein openings (4) in the conductor carrier strip (10) are directed toward pockets (3) of the blister package (1), and wherein, upon removal of a tablet (2) from a pocket (3), a sealing film (13) of the blister package (1) sealing the pocket (3) may be separated, and the tablet (2) is removable through an opening (4) assigned to it, characterized in that the openings (4) are formed by stamped lines (41) positioned within the conductor carrier strip (10) that surround each of the pockets (3) in a ring shape, and are interrupted by at least two spars (42, 43) by means of which a covering (30) separated by the stamped line (41) out of the conductor carrier strip (10) and covering the pocket (3) is connected with the conductor carrier strip (10); that the spars (42, 43) are so distributed about the circumference of the stamped line (41) that, when a tablet (2) is pressed out from a pocket (3), at least one spar (42) is broken; and that the conductor carrier strip (10) includes individual conductors (52) each of which extends from an individual connection point (51) over at least the one spar (42) that is broken upon tablet removal.

2. Blister package arrangement as in Claim 1, characterized in that the individual connection points (52) and the common connection point (54) are components of an interface (5) that, when the blister package arrangement is inserted into a receiver device (40), only one physical polarity is possible, and is connected electrically with an electronic unit positioned in the receiver device (40) to determine interruption of the individual conductors (52).

3. Blister package arrangement as in Claim 2, characterized in that the individual connection points (51) and the common connection point (54) are components of an interface, which upon insertion of the blister package arrangement in a receiver device, effect a defined position orientation and are electrically connected with an electronic unit in the receiver device to detect the interruption of the individual conductors.

4. Blister package arrangement as in one of Claims 1 through 3, characterized in that the stamped lines (41) are rectangular, circular, or oval in shape.

5. Blister package arrangement as in one of Claims 1 through 4, characterized in that the spars (43) are positioned diametrically opposite each other about the circumference of the

stamped line (41), and that the individual conductor (52) extends over both spars (42, 43).

6. Blister package arrangement as in Claim 5, characterized in that the two spars (42, 43) each lie along the direction of the longer extension of the stamped line (41).

7. Blister package arrangement as in one of Claims 1 through 6, characterized in that the individual conductor (52) extends over the first and the additional spars (42, 43).

8. Blister package arrangement as in one of Claims 1 through 4, characterized in that the individual conductor (52) extends only over one of the spars (42 or 43) from the conductor carrier strip (10) to the covering (30), and from the covering (30) back to the conductor carrier strip (10) as a loop, whereby the conductor-bearing spar (42 or 43) is positively broken upon tablet removal.

9. Blister package arrangement as in one of Claims 1 through 8, characterized in that the conductor carrier strip (10) includes the individual conductors (52) on the side facing away from the blister package (1), and is attached, preferably adhered, to the side facing toward the blister package (1) by means of the sealing film (13) of the blister package (1).

10. Blister package arrangement as in Claim 9, characterized in that the conductor carrier strip (10) is at least partially provided with an electrically insulating protective layer (12) on its side facing away from the blister package (1) that covers at least the individual conductors (52) and the common conductor (53).

11. Blister package arrangement as in one of Claims 1 through 8, characterized in that the conductor carrier strip (10') includes the individual conductors (52') on its side facing toward the blister package (1'), and that the side of the conductor carrier strip (10) facing toward the blister package (1') is provided with an electrically insulating layer (54') covering the individual conductors (52'), and that the side of the electrically insulating layer (54') facing toward the blister package (1') is connected with the sealing film (13') of the blister package (1).

12. Blister package arrangement as in Claim 11, characterized in that the electrically insulating layer (54') is provided with an adhesive layer (66') that may be connected with the sealing film (13') of the blister package (1'), or that the electrically insulating layer is simultaneously an adhesive layer that may be connected to the sealing film (13') of the blister package (1').

13. Blister package arrangement as in Claim 12, characterized in that the adhesive layer (66′) is covered by a tear film (63′) that may be separated from the adhesive layer (66′) in order to connect the adhesive layer (66′) to the sealing film (13′).

14. Blister package arrangement as in one of Claims 1 through 13, characterized in that the conductor carrier strip (10′) projects over the blister package (1) at least on the side of the interface (5).

15. Blister package arrangement as in one of Claims 1 through 14, characterized in that the conductor carrier strip (10, 10′) forms the first component of the carrier strip (60) that folds like a book, and whose second component (63) is an insertion opening (62) for each pocket (3, 3′) of the blister package (1, 1′) or a common insertion opening (62′) for all pockets (3, 3′) of the blister package (1, 1′), and may be folded about a fold line (61) with respect to the conductor carrier strip (10, 10′) so that the blister package (1, 1′) is accepted between the conductor carrier strip (10, 10′) and the second part (63), whereby each pocket (3, 3′) of the blister package (1, 1′) extends through an insertion opening (62) of the second component (63) or all pockets (3, 3′) of the blister package (1, 1′) through the common insertion opening (63′) of the second component (63), and that the conductor carrier strip (10, 10′),

the blister package (1, 1'), and the second component receiving the pockets (3, 3') of the blister package (1, 1') are connected with each other, preferably adhered.

16. Blister package arrangement as in Claim 15, characterized in that the conductor carrier strip (10, 10') and the second component (63) project over the blister package (1, 1') at least on the side of the interface (5) of the conductor carrier strip (10, 10').

17. Blister package arrangement as in Claim 16, characterized in that the conductor carrier strip (10, 10') and the second component (63) project over the blister package (1, 1') on all sides.

18. Blister package arrangement as in one of Claims 15 through 17, characterized in that the fold line (61) extends along the longer side of the conductor carrier strip (10, 10') and the second component (63).